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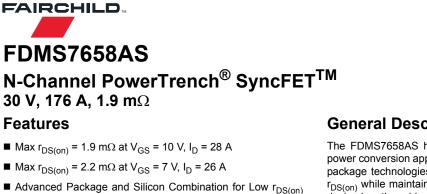


ON Semiconductor®

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- and High Efficiency ■ SyncFETTM Schottky Body Diode
- MSL1 Robust Package Design
- 100% UIL Tested
- RoHS Compliant

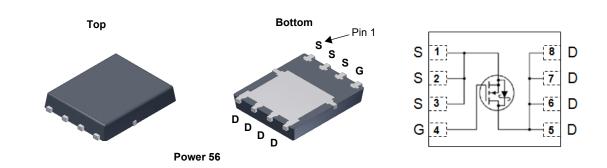


General Description

The FDMS7658AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{\text{DS}(\text{on})}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU Low Side Switch
- Networking Point of Load Low Side Switch
- Telecom Secondary Side Rectification



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	176		
	-Continuous	T _C = 100 °C	(Note 5)	112	A	
D	-Continuous	T _A = 25 °C	(Note 1a)	29		
	-Pulsed		(Note 6)	670		
dv/dt	MOSFET dv/dt			1.5	V/ns	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	162	mJ	
P _D	Power Dissipation	T _C = 25 °C		89	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.4	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (N	Note 1a)	50	C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7658AS	FDMS7658AS	Power 56	13 "	12 mm	3000 units

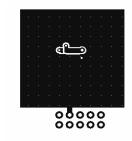
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Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		23		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			500	μA	
I _{GSS}	Gate to Source Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA	
On Chara	cteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	1.2	1.7	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		-5		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 28 A		1.5	1.9		
		V _{GS} = 7 V, I _D = 26 A		1.7	2.2	- mΩ	
		V _{GS} = 4.5 V, I _D = 23 A		1.9	2.4		
		V_{GS} = 10 V, I _D = 28 A, T _J = 125 °C		2.0	2.6		
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 28 A		181		S	
-	Characteristics					_	
C _{iss}	Input Capacitance	V _{DS} = 15 V, V _{GS} = 0 V,		5525	7350	pF	
C _{oss}	Output Capacitance	f = 1 MHz		2020	2685	pF	
C _{rss}	Reverse Transfer Capacitance			150	230	pF	
Rg	Gate Resistance		0.1	0.4	0.9	Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time			20	36	ns	
t _r	Rise Time	V _{DD} = 15 V, I _D = 28 A,		8	17	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		43	70	ns	
t _f	Fall Time			5	10	ns	
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		78	109	nC	
Q _q	Total Gate Charge	V_{GS} = 0 V to 4.5 V V_{DD} = 15 V,		35	49	nC	
∽g		1 00 1		40.4			
Q _{gs}	Gate to Source Gate Charge	I _D = 28 A		16.4		nC	

Drain-Source Diode Characteristics

V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.38	0.9	V
		$V_{GS} = 0 V, I_S = 28 A$ (Note 2)		0.74	1.3	
t _{rr}	Reverse Recovery Time	I _F = 28 A, di/dt = 300 A/μs		46	75	ns
Q _{rr}	Reverse Recovery Charge	$-1_{\rm F} - 20$ A, di/dt - 500 A/µs		73	117	nC

Notes: 1. R_{0,JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.

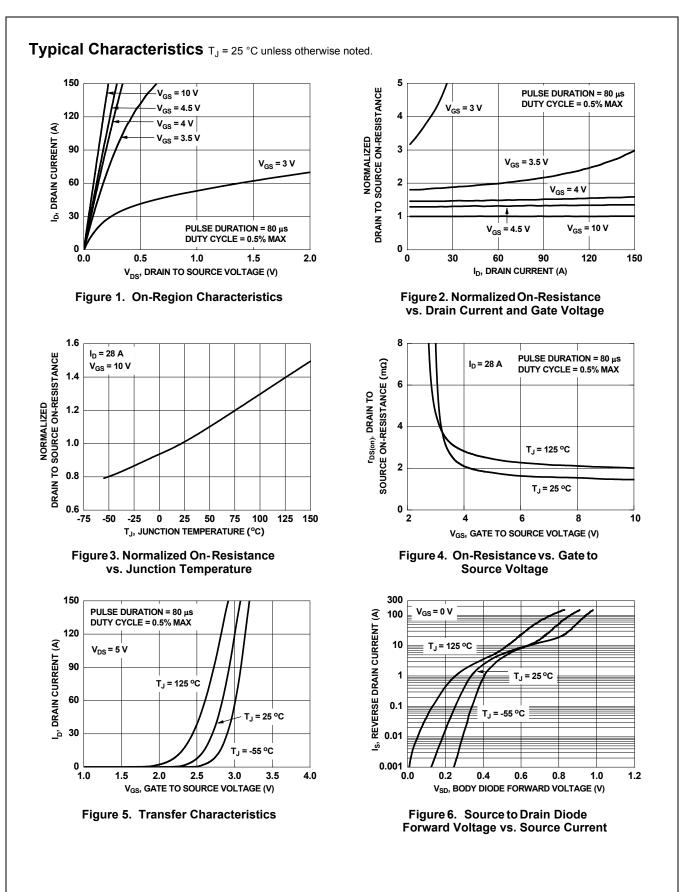


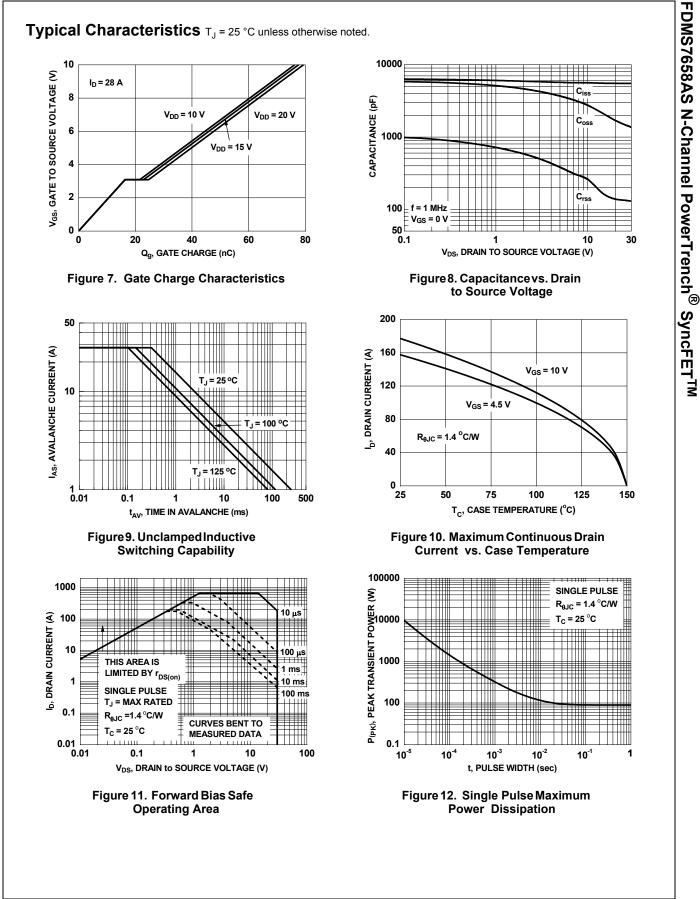
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

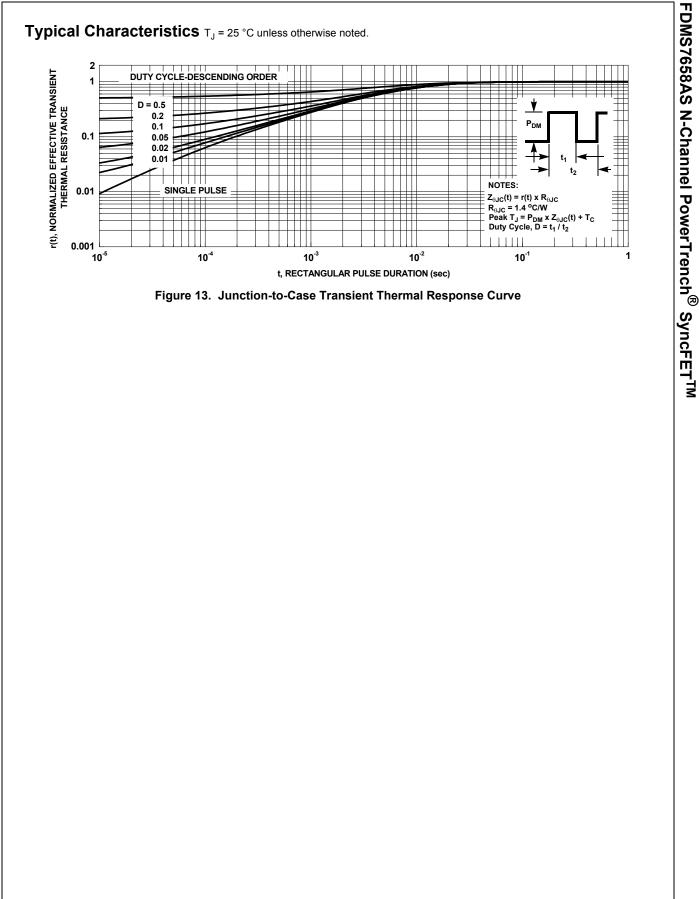




Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
E_{AS} of 162 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 18 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 28 A.
As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.
Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.
Pulsed Id please refer to Fig 11 SOA graph for more details.







Typical Characteristics (continued)

SyncFET[™] Schottky body diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS7658AS.

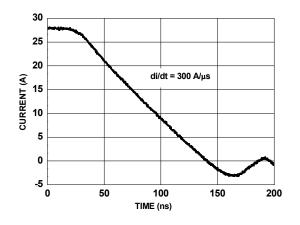


Figure 14. FDMS7658AS SyncFET[™] Body Diode Reverse Recovery Characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

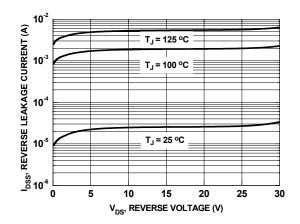
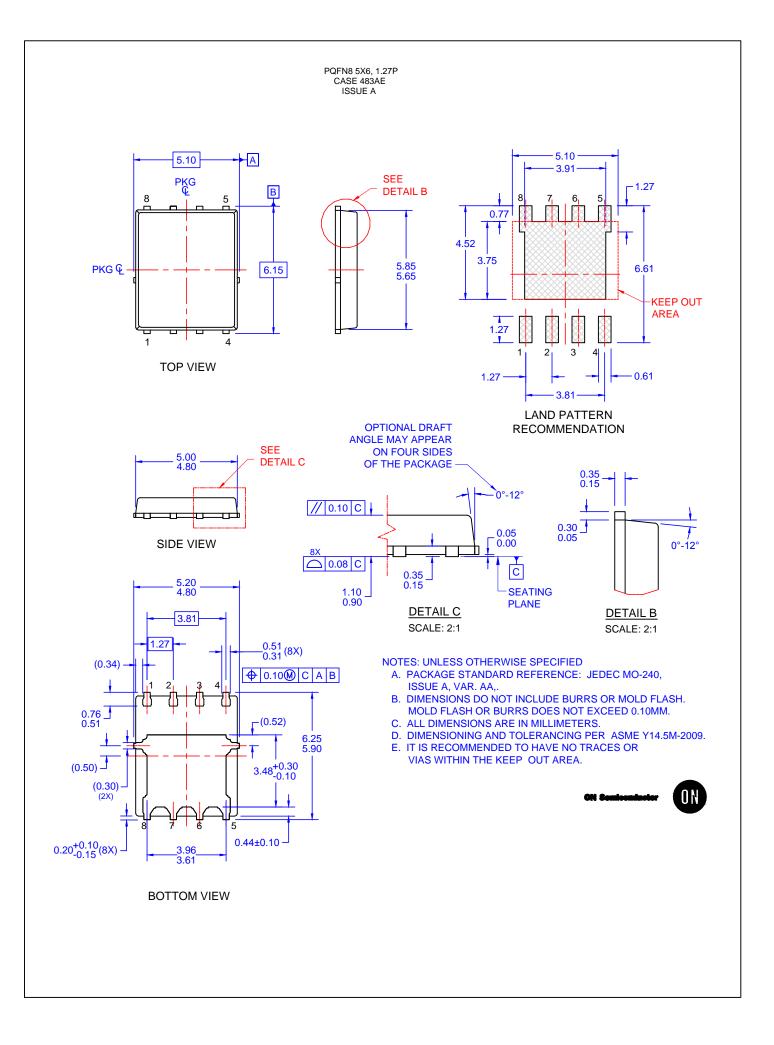


Figure 15. SyncFET[™] Body Diode Reverses Leakage vs. Drain-Source Voltage



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